Miniaturized High Performance, Energy and Area Efficient Field-Effect Transistor Expands Computational Capability of Electronic Devices

Allows for the use of sub-50-nm channels with no adverse effects

As designers of integrated circuit components attempt to scale their dimensions below the 20 nanometer range, physical limitations as well as device performance issues become problematic. In particular, reducing the gate length of a transistor below 50 nm can lead to short-channel effects.

KAUST has designed a novel, low-cost field effect transistor (FET) that can miniaturize to the 5- to 40-nm range without being hindered by the short-channel effects of other designs. This unique architecture offers a significant improvement in performance, most notably in output current value, sub-threshold slope, transconductance, speed and more prominently in reducing leakage power consumption.

By enabling greater density of transistors in an integrated circuit, this critical technology expands the computational ability of electronic devices.



TECHNOLOGY OPPORTUNITY



Benefits

- Improved performance: Mitigates short-channel effects to allow higher density of smaller transistors, improving device performance
- Faster response: Offers sharper, faster lon/loff performance than conventional transistors
- Low cost: Can be manufactured less expensively and with higher yields than conventional transistors
- Low power: Offers reduced leakage current resulted power consumption by introducing core-shell gate stacks
- Area efficiency: Can be integrated using ultra-largescale-integration (ULSI) to enable multi-functionality in complex ICs

Applications

This technology will benefit all manner of semiconductor nanoelectronics devices:

- Ultra-mobile computation by introducing high performance mobile devices like iPad, tablets and smart phones
- Establishing energy efficient ultralarge-scale data handling capable sensor networks

Opportunity

This technology is part of KAUST's technology commercialization program that seeks to stimulate development and commercial use of KAUST-developed technologies.

Opportunities exist for joint development, patent licensing, or other mutually beneficial relationships.

For More Information

ip@kaust.edu.sa

Technology Details

KAUST has developed a cylindrical-shaped, multi-gate conventional channel material (Si, SiGe, III-V) nanotube field effect transistor for use in semiconductor nanoelectronics devices. The technology's unique design overcomes the challenging performance issues that arise when attempting to scale down integrated circuit components.

How It Works

KAUST's novel architecture relies upon volume-inversion effects to improve performance in multi-gate devices. The volume-inversion effects are introduced when the thickness of the semiconductor film is reduced below the inversion layer thickness induced by the multiple gates.

This technique introduces a number of advantages, including:

- Enhanced number of minority carriers
- Increased velocity saturation
- Increased drain current and transconductance
- Decreased leakage current related power consumption

This, in turn, improves the performance of current value, subthreshold slope, and speed.

Why It Is Better

The number of transistors in integrated circuits doubles approximately every 1.5 years. Moore's Law has proved to be remarkably consistent ever since the invention of the integrated circuit in 1958. For the semiconductor industry to maintain this level of advancement, many design challenges must be overcome.

KAUST's novel FET architecture provides a critical advance, enabling further miniaturization of transistors in integrated circuits. The innovative design offers full-volume inversion, excellent electrostatic control, and ballistic transport. By mitigating short-channel effects, the technology successfully allows in increase in the number of transistors per chip, improving overall performance.

IP Protection

KAUST has several patents pending for this technology.



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